onsemi

MOSFET – N-Channel, POWERTRENCH[®]

60 V

FDC5612

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{DS(ON)}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

Features

- 4.3 A, 60 V.
 - , 60 V. $R_{DS(ON)} = 0.055 \Omega @ V_{GS} = 10 V$
 - $R_{DS(ON)} = 0.064 \ \Omega @ V_{GS} = 6 \ V$
- Low Gate Charge (12.5 nC Typical)
- Fast Switching Speed
- High Performance Trench Technology for Extremely Low R_{DS(ON)}.
- SUPERSOTTM-6 Package: Small Footprint (72% Smaller than Standard SO-8); Low Profile (1mm Thick).
- This is a Pb–Free and Halide Free Device

ABSOLUTE MAXIMUM RATINGS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	60	V
V _{GSS}	Gate-Source Voltage	±20	V
Ι _D	Drain Current –Continuous (Note 1a) –Pulsed	4.3 20	A
P _D	Power Dissipation for Single Operation (Note 1a) (Note 1b)	1.6 0.8	W
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	78	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case (Note 1)	30	°C/W

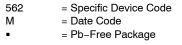
V _{DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	0.055 Ω @ 10 V	4.3 A
	0.064 Ω @ 6 V	



TSOT23 6-Lead (SUPERSOT [™] -6) CASE 419BL

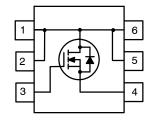
MARKING DIAGRAM





(Note: Microdot may be in either location)

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping [†]
FDC5612	TSOT–23–6 (SUPERSOT™–6)	3000 / Tape & Reel
	(Pb-Free)	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit				
OFF CHARAC	OFF CHARACTERISTICS									
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μ A	60	_	_	V				
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C	-	58	-	mV/°C				
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA				
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	100	nA				
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20$ V, $V_{DS} = 0$ V	-	-	-100	nA				

ON CHARACTERISTICS (Note 2)

V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	2.2	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	-	-5.5	-	mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$ \begin{array}{l} V_{GS} = 10 \; V, \; I_{D} = 4.3 \; A \\ V_{GS} = 10 \; V, \; I_{D} = 4.3 \; A, \; T_{J} = 125^{\circ}C \\ V_{GS} = 6 \; V, \; I_{D} = 4 \; A \end{array} $	- - -	0.042 0.072 0.048	0.055 0.094 0.064	Ω
I _{D(on)}	On-State Drain Current	V_{GS} = 10 V, V_{DS} = 5 V	10	-	-	Α
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$	-	14	_	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	-	650	-	pF
C _{oss}	Output Capacitance		-	80	-	pF
C _{rss}	Reverse Transfer Capacitance		-	35	-	pF

SWITCHING CHARACTERISTICS (Note 2)

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 1 \text{ A},$	-	11	20	ns
t _r	Turn-On Rise Time	V _{GS} = 10 V, R _{GEN} = 6 Ω	-	8	18	ns
t _{d(off)}	Turn-Off Delay Time		-	19	35	ns
t _f	Turn-Off Fall Time		-	6	15	ns
Qg	Total Gate Charge	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 4.3 \text{ A},$	-	12.5	18	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V	-	2.4	_	nC
Q _{gd}	Gate-Drain Charge		-	2.6	_	nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

۱ _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	1.3	А
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I _S = 1.3 A (Note 2)	-	0.75	1.2	V

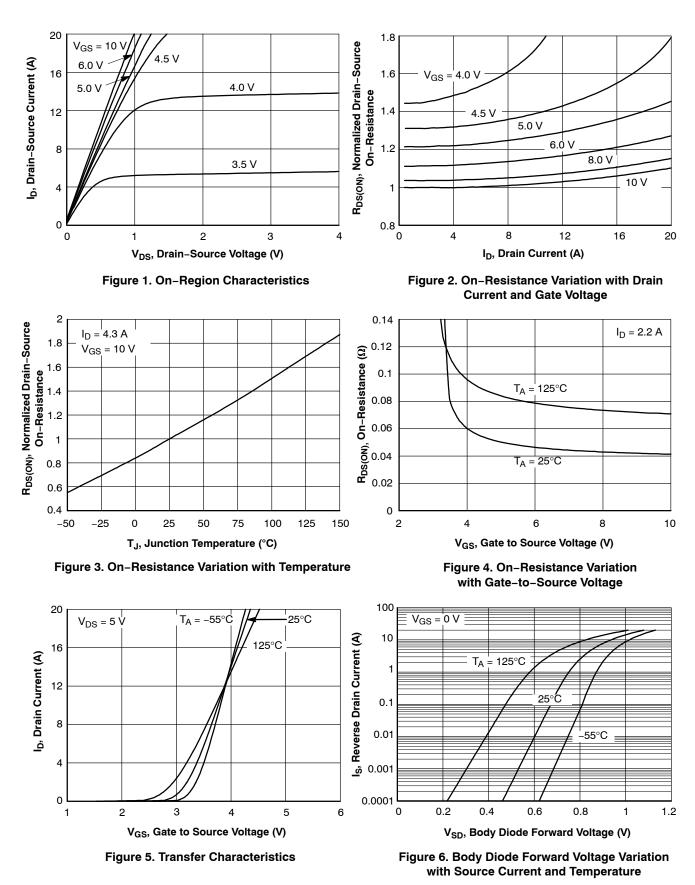
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

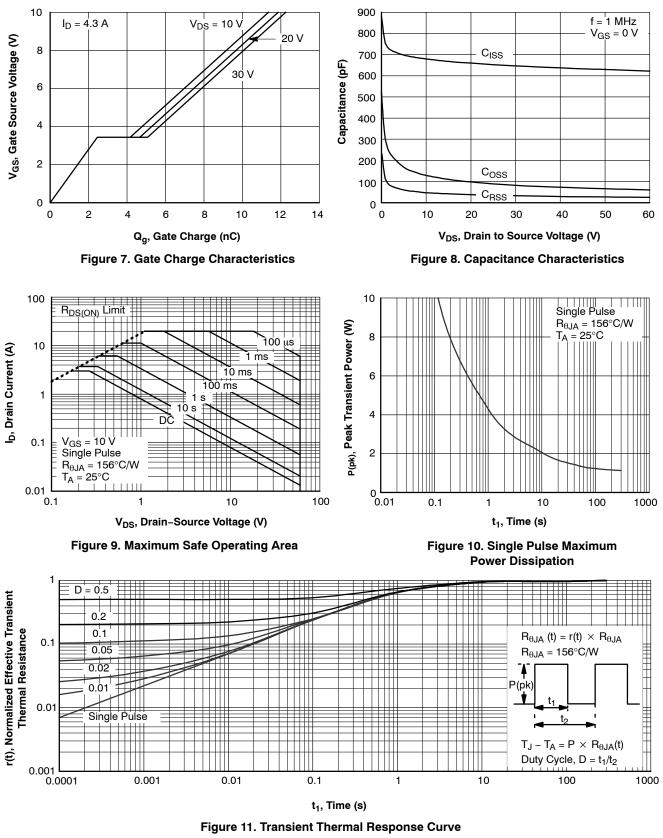
1. R_{0JA} is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. a) 78°C/W when mounted on a 1 in² pad of 2 oz copper.

b) 156° C/W when mounted on a minimum pad. 2. Pulse Test: Pulse Width $\leq 300 \ \mu$ s, Duty Cycle $\leq 2.0\%$.

TYPICAL CHARACTERISTICS



TYPICAL ELECTRICAL CHARACTERISTICS (continued)

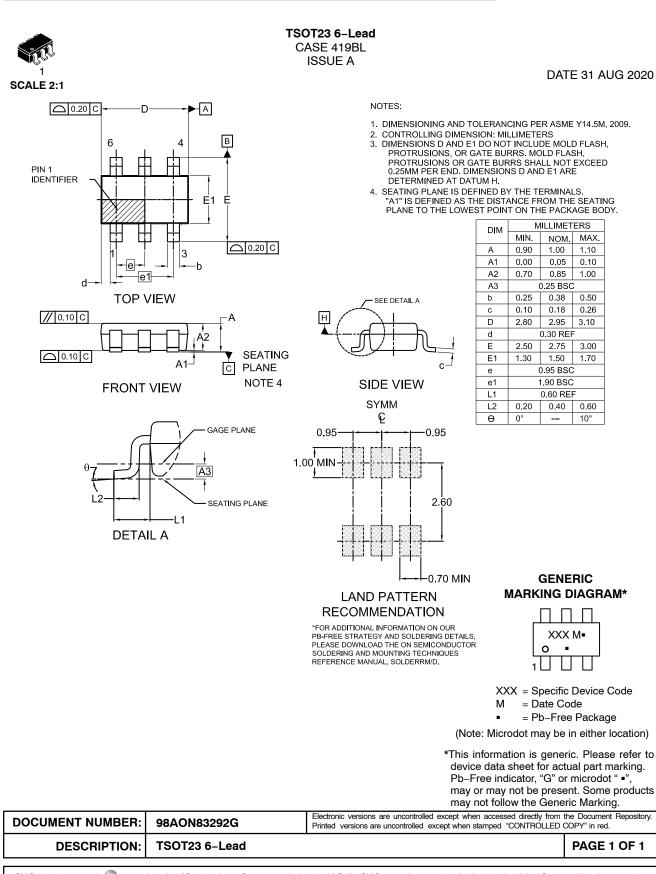


NOTE: Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

POWERTRENCH is a registered trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

SUPERSOT is a trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.





ON Semiconductor and ()) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales